



AP21410 / AP21510

0.2A SINGLE CHANNEL CURRENT-LIMITED POWER SWITCH

Description

The AP21410 and AP21510 are integrated high-side power switches optimized for Universal Serial Bus (USB) and other hot-swap applications. The family of devices complies with USB 2.0 and is available with both polarities of Enable input. They offer current and thermal limiting and short circuit protection as well as controlled rise time and undervoltage lockout functionality.

All devices are available in U-DFN2018-6 packages.

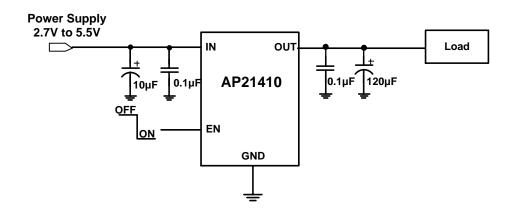
Features

- Single USB Port Power Switches
- Overcurrent and Thermal Protection
- 0.4A Typical Current Limiting
- Reverse Current Blocking
- 95mΩ On-Resistance
- Input Voltage Range: 2.7V to 5.5V
- 0.4ms Typical Rise Time
- Very Low Shutdown Current: 1µA (Max)
- ESD Protection: 4KV HBM, 400V MM
- Active Low (AP21410) or Active High (AP21510) Enable
- Ambient Temperature Range -40°C to +85°C
- U-DFN2018-6: Available in "Green" Molding Compound (No Br, Sb)
- 15kV ESD Protection per IEC 61000-4-2 (with External Capacitance)
- UL Recognized, File Number E322375
- IEC60950-1 CB Scheme Certified
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

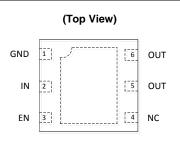
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Typical Applications Circuit



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Pin Assignments



U-DFN2018-6

Applications

- Consumer Electronics LCD TVs & Monitors, Game Machines
- Communications Set-Top Boxes, GPS, Smartphones
- Computing Laptops, Desktops, Servers, Printers, Docking Stations, HUBs



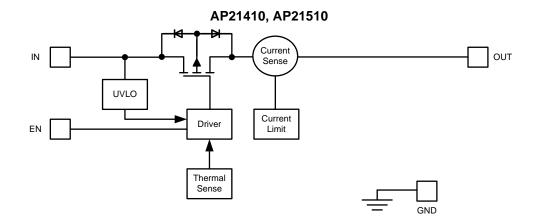
Available Options

Part Number	Channel	Enable Pin (EN)	Current Limit (Typical)	Recommended Maximum Continuous Load Current
AP21410	1	Active Low	0.4A	0.2A
AP21510	1	Active High	0.4A	0.2A

Pin Descriptions

Pin Number	Pin Name	Function
1	GND	Ground
2	IN	Voltage Input Pin (all IN pins must be tied together externally).
3	EN	Enable Input. Active Low (AP21410) and Active High (AP21510)
4	NC	No internal connection
5, 6	OUT	Voltage Output Pin (all OUT pins must be tied together externally).
Exposed Pad	Exposed Pad	Exposed Pad. It should be externally connected to GND plane and thermal mass for enhanced thermal impedance. It should not be used as electrical ground conduction path.

Functional Block Diagram





Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Symbol		Parameter			Units
	НВМ	Human Body Model ESD Protection		4	kV
	MM	Machine Model ESD Protection		400	V
ESD	IEC System	Surges per EN61000-4-2. 1999 applied to output terminals of EVM (Note 5)	Air	15	kV
Level	Surges per EN61000-4-2. 1999 applied to output terminals of EVM (Note 5) Contact		8	kV	
V _{IN}	Input Voltage			6.5	V
Vout	Output Voltag	Output Voltage			V
V _{EN}	Enable Volta	Enable Voltage			V
ILOAD	Maximum Co	Maximum Continuous Load Current			А
T _{J(MAX)}	Maximum Jur	Maximum Junction Temperature			°C
T _{ST}	Storage Tem	Storage Temperature Range (Note 4)			°C

Caution: Stresses greater than the 'Absolute Maximum Ratings' specified above, may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time. Semiconductor devices are ESD sensitive and may be damaged by exposure to ESD events. Suitable ESD precautions should be taken when handling and transporting these devices.

Notes:

 UL Recognized Rating from -30°C to +70°C (Diodes qualified T_{ST} from -65°C to +150°C).
External capacitors need to be connected to the output, EVM board was tested with capacitor 2.2µF 50V 0805. This level is a pass test only and not a limit.

Recommended Operating Conditions (@TA = +25°C, unless otherwise specified.)

Symbol	Parameter	Min	Max	Units
V _{IN}	Input Voltage	2.7	5.5	V
I _{OUT}	Output Current	0	200	mA
T _A	Operating Ambient Temperature	-40	+85	°C
VIL	EN Input Logic Low Voltage	0	0.8	V
V _{IH}	EN Input Logic High Voltage	2	V _{IN}	V



Electrical Characteristics (@T_A = +25°C, V_{IN} = +5.0V, unless otherwise specified.)

Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
V _{UVLO}	Input UVLO	$R_{LOAD} = 1k\Omega$			1.6	1.9	2.5	V
I _{SHDN}	Input Shutdown Current	Disabled, I _{OUT} =	: 0		_	0.5	1	μA
lq	Input Quiescent Current	Enabled, I _{OUT} =	0		_	45	70	μA
I _{LEAK}	Input Leakage Current	Disabled, OUT (Grounded		_	_	1	μA
I _{REV}	Reverse Leakage Current	Disabled, V _{IN} =	0V, V _{OUT} = 5V, I _{RE}	ev at V _{IN}	_	0.01	1	μA
		V _{IN} = 5V,	T _A = +25°C	U-DFN2018-6	_	80	110	
_		$I_{OUT} = 0.2A$	$-40^{\circ}C \le T_A \le +85$	-40°C ≤ T _A ≤ +85°C		_	140	mΩ
R _{DS(ON)}	Switch On-Resistance	V _{IN} = 3.3V, I _{OUT} = 0.2A	T _A = +25°C		—	100	140	
			-40°C ≤ T _A ≤ +85°C		_	_	170	
I _{SHORT}	Short-Circuit Current Limit	Enabled into Sh	Enabled into Short Circuit			250	_	mA
TSHORT	Short-Circuit Response Time	VOUT = 0V to IOUT = ISHORT (OUT shorted to ground) Note: See Figure 2		_	2	—	μs	
ILIMIT	Over-Load Current Limit	$V_{IN} = 5V, V_{OUT} = 4.5V, -40^{\circ}C \le T_A \le +85^{\circ}C$		300	400	500	mA	
Isink	EN Input Leakage	V _{EN} = 5V		_	_	1	μA	
t _{D(ON)}	Output Turn-On Delay Time	$R_{LOAD} = 25\Omega$		_	0.05	_	ms	
t _R	Output Turn-On Rise Time	$R_{LOAD} = 25\Omega$	$R_{LOAD} = 25\Omega$		_	0.4	1.5	ms
t _{D(OFF)}	Output Turn-Off Delay Time	$R_{LOAD} = 25\Omega$		_	0.14	_	ms	
t _F	Output Turn-Off Fall Time	$R_{LOAD} = 25\Omega$		_	0.04	0.1	ms	
T _{SHDN}	Thermal Shutdown Threshold	Enabled, $R_{LOAD} = 1k\Omega$		—	+140	_	°C	
T _{HYS}	Thermal Shutdown Hysteresis	_		—	+25	—	°C	
θ_{JA}	Thermal Resistance Junction-to- Ambient	U-DFN2018-6 (Note 6)		_	70	—	°C/W	

Note: 6. Test condition for U-DFN2018-6: Device mounted on FR-4 2-layer board, 2oz copper, with minimum recommended pad on top layer and 3 vias to bottom layer 1.0" x 1.4" ground plane.



Performance Characteristics

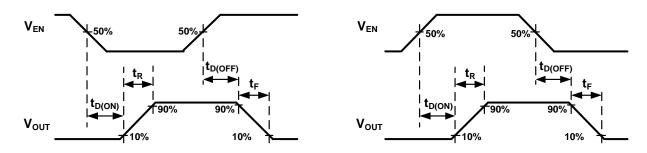
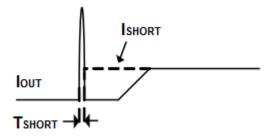
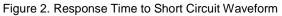
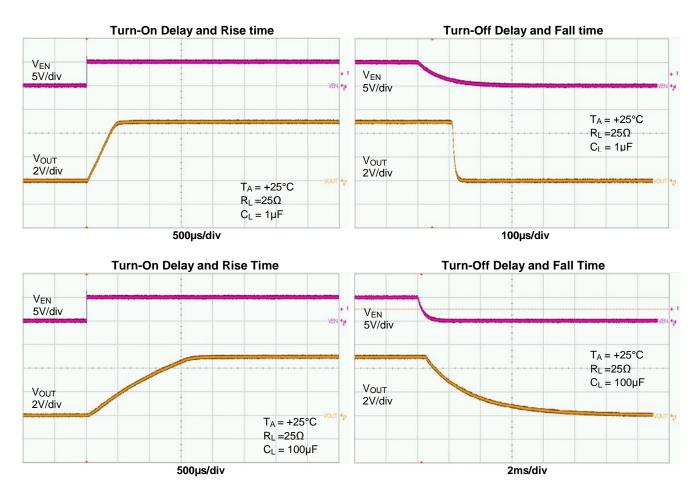


Figure 1. Voltage Waveforms: AP21410 (Left), AP21510 (Right)

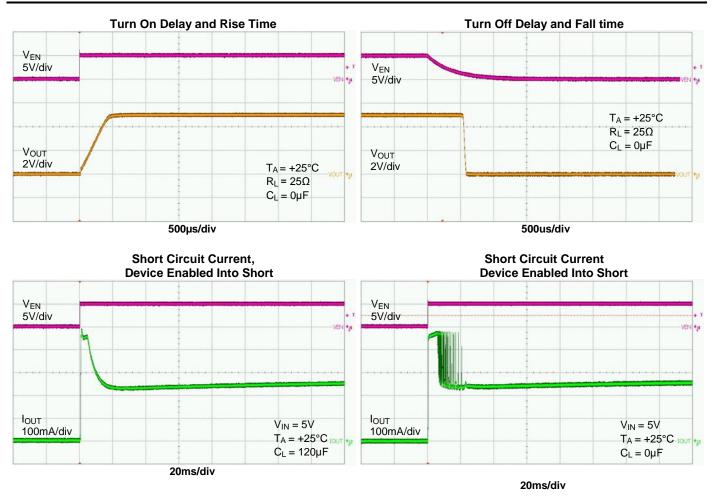


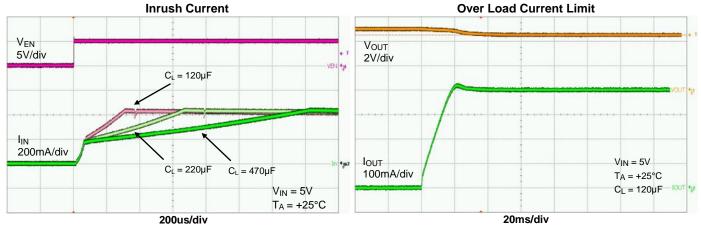






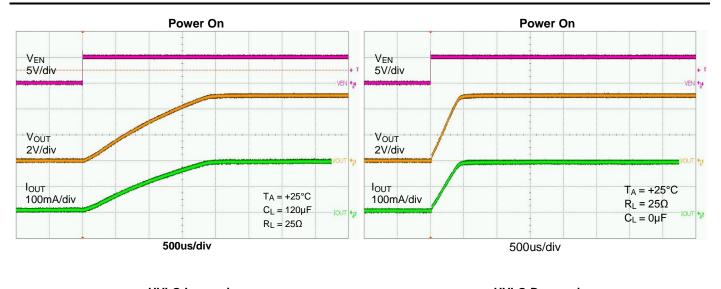
Performance Characteristics (continued)

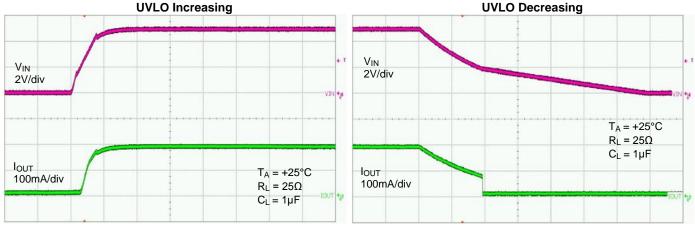






Performance Characteristics (cont.)



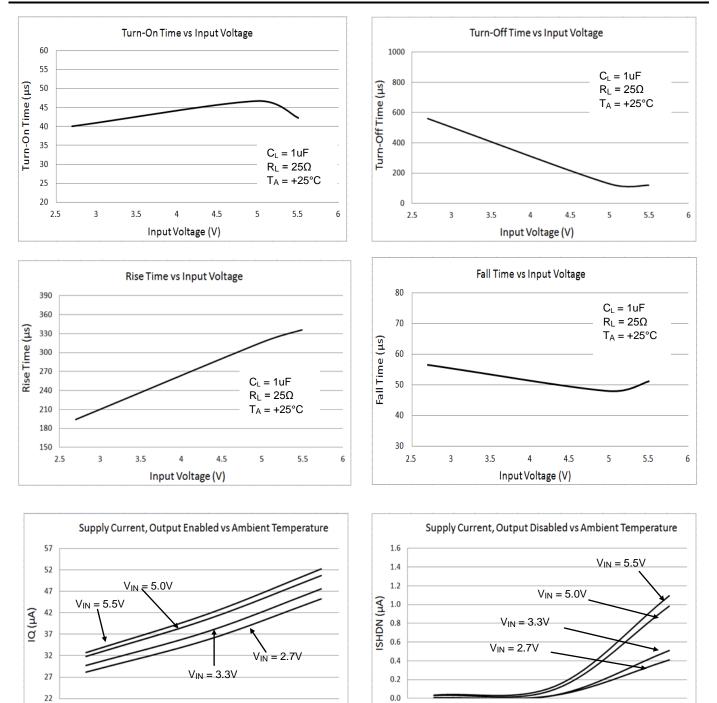


1ms/div

10ms/div



Performance Characteristics (cont.)



-40

-60

-20

0

20

Ambient Temperature (°C)

40

60

100

80

-40

-60

-20

0

20

Ambient Temperature (°C)

40

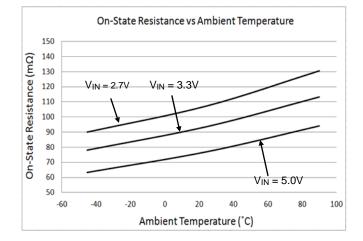
60

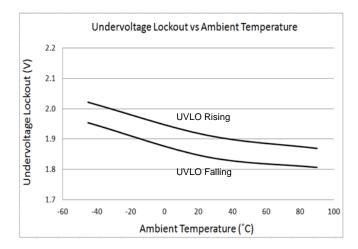
80

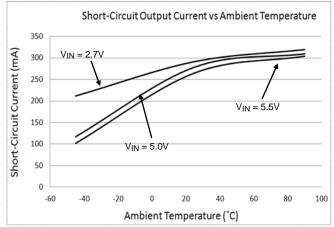
100



Performance Characteristics (cont.)









Application Information

Power Supply Considerations

Overcurrent and Short Circuit Protection

the immunity of the device to short-circuit transients.

An internal sensing FET is employed to check for overcurrent conditions. Unlike current-sense resistors, sense FETs do not increase the series resistance of the current path. When an overcurrent condition is detected, the device maintains a constant output current and reduces the output voltage accordingly. Complete shutdown occurs only if the fault stays long enough to activate thermal limiting.

Three possible overload conditions can occur. In the first condition, the output has been shorted to GND before the device is enabled or before VIN has been applied. The AP21410 / AP21510 short circuit and clamps output current to a certain safe level namely I_{SHORT}.

In the second condition, an overload occurs while the device is enabled. At the instance the overload occurs, higher current may flow for a very short period of time before the current-limit function can react. After the current limit function has tripped (reached the overcurrent trip threshold), the device switches into current limiting mode and the current is clamped at ILIMIT.

In the third condition, the load has been gradually increased beyond the recommended operating current. The current is permitted to rise until the current-limit threshold is reached or until the thermal limit of the device is exceeded. The AP21410 / AP21510 is capable of delivering current up to the current-limit threshold without damaging the device. Once the threshold has been reached, the device switches into overload current limiting mode and is set at ILIMIT. If the load current keeps going higher, the device will switch into short-circuit current limiting mode and is set at ISHORT.

Note that when the output has been shorted to GND at extremely low temperatures (< -30°C), a minimum 120µF electrolytic capacitor on the output pin is recommended. A correct capacitor type with capacitor voltage rating and temperature characteristics must be properly chosen so that the capacitance value does not drop too low at the extremely low temperature operation. A recommended capacitor should have temperature characteristics of less than 10% variation of capacitance change when operated at extremely low temp. Our recommended aluminum electrolytic capacitor type is Panasonic FC series.

Power Dissipation and Junction Temperature

The low on-resistance of the internal MOSFET allows the small surface-mount packages to pass large current. Using the maximum operating ambient temperature (T_A) and R_{DS(ON)}, the power dissipation can be calculated by:

$$P_{\rm D} = R_{\rm DS(ON)} \times I^2$$

Finally, calculate the junction temperature:

$$T_{J} = P_{D} \times R_{\theta JA} + T_{A}$$

Where:

T_A = Ambient temperature °C

 $R_{\theta,JA}$ = Thermal resistance

P_D = Total power dissipation



Application Information (continued)

Thermal protection prevents the IC from damage when heavy overload or short-circuit faults are present for extended periods of time. The AP21410 / AP21510 implements a thermal sensing to monitor the operating junction temperature of the power distribution switch. Once the die temperature rises to approximately +140°C due to excessive power dissipation in an overcurrent or short-circuit condition, the internal thermal sense circuitry turns the power switch off, thus preventing the power switch from damage. Hysteresis is built into the thermal sense circuit allowing the device to cool down approximately +25°C before the switch turns back on. The switch continues to cycle in this manner until the load fault or input power is removed.

Undervoltage Lockout (UVLO)

Undervoltage lockout function (UVLO) keeps the internal power switch from being turned on until the power supply has reached at least 1.9V, even if the switch is enabled. Whenever the input voltage falls below approximately 1.9V, the power switch is quickly turned off. This facilitates the design of hot-insertion systems where it is not possible to turn off the power switch before input power is removed.

Generic Hot-Plug Applications

In many applications it may be necessary to remove modules or pc boards while the main unit is still operating. These are considered hot-plug applications. Such implementations require the control of current surges seen by the main power supply and the card being inserted. The most effective way to control these surges is to limit and slowly ramp the current and voltage being applied to the card, similar to the way in which a power supply normally turns on. Due to the controlled rise times and fall times of the AP21410 / AP21510, these devices can be used to provide a softer start-up to devices being hot-plugged into a powered system. The UVLO feature of the AP21410 / AP21510 also ensures that the switch is off after the card has been removed, and that the switch is off during the next insertion.

By placing the AP21410 / AP21510 between the V_{CC} input and the rest of the circuitry, the input power reaches these devices first after insertion. The typical rise time of the switch is approximately 1ms, providing a slow voltage ramp at the output of the device. This implementation controls system surge current and provides a hot-plugging mechanism for any device.

Dual-Purpose Port Applications

AP21410/AP21510 is suitable for use in dual-purpose port applications in which a single port is used for data communication between the host and peripheral devices while simultaneously maintaining a charge to the battery of the peripheral device. An example of this is a shared HDMI/MHL (Mobile High-definition Link) port that allows streaming video between an HDTV or set-top box and a smartphone or tablet while maintaining a charge to the smartphone or tablet battery. In such dual-purpose port applications, it is important to insure Vin of the AP21410/AP21510 is ramped to its operating voltage prior to enabling the output.

No Output Capacitor Applications

For certain applications, no output capacitor is allowed. It is recommended to add a schottky diode at the output pin to prevent the device damaged by output accidently short to ground.

Note: All previous Typical Performance Characteristics charts marked $C_L=0\mu F$ have the schottky diode added.

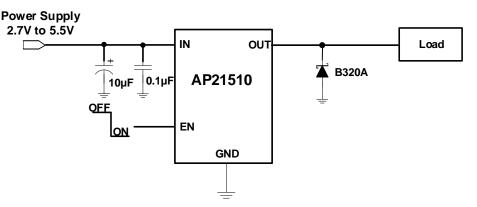
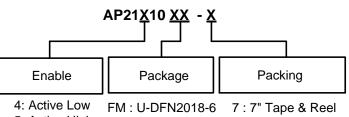


Figure 3. No Output Capacitor Application



Ordering Information (Note 7)



5: Active High

Part Number	Package Code Packaging		7" Tape	and Reel	
Fait Nulliber	Fackage Coue	Fackaging	Quantity	Part Number Suffix	
AP21410FM-7	FM	U-DFN2018-6	3,000/Tape & Reel	-7	
AP21510FM-7	FM	U-DFN2018-6	3,000/Tape & Reel	-7	

Note: 7. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

(1) U-DFN2018-6



 $\frac{XX}{Y} : Identification Code$ <u>Y</u> : Year : 0~9<u>W</u>: Week : A~Z : 1~26 week; a~z : 27~52 week; z represents 52 and 53 week

X : Internal Code

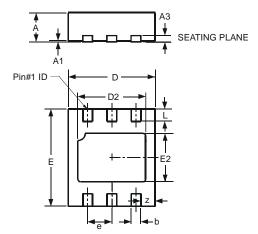
Device	Package Type	Identification Code	
AP21410FM	U-DFN2018-6	GA	
AP21510FM	U-DFN2018-6	GP	



Package Outline Dimensions (All dimensions in mm.)

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

(1) Package Type: U-DFN2018-6

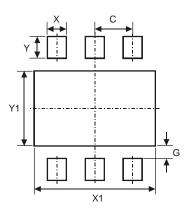


	U-DFN2018-6					
Dim	Min	Max	Тур			
Α	0.545	0.605	0.575			
A1	0	0.05	0.02			
A3			0.13			
b	0.15	0.25	0.20			
D	1.750	1.875	1.80			
D2	1.30	1.50	1.40			
е	—	_	0.50			
Е	1.95	2.075	2.00			
E2	0.90	1.10	1.00			
L	0.20	0.30	0.25			
z		_	0.30			
All D	All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

(1) Package Type: U-DFN2018-6



Dimensions	Value (in mm)
С	0.50
G	0.20
Х	0.25
X1	1.60
Y	0.35
Y1	1.20



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